

PAD AREA  
 KEEP AREA  
 KEEP OUT AREA

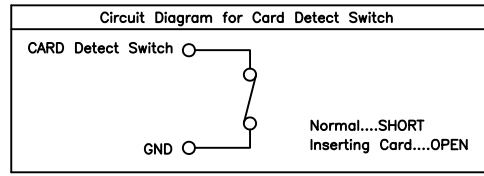
PART NUMBER:  
**4MCGD - 0 7 \* T - 1 2 2**  
 SERIES ——— NO. OF POS. ——— TAPE REEL PACKAGE ———  
 CONTACT PLATED OPTION ——— TIN PLATING ON SOLDER TAIL ———  
 1: GOLD FLASH  
 3: 3u" GOLD  
 5: 5u" GOLD  
 6: 10u" GOLD

**MATERIALS**

HOUSING: HI-TEMP. PLASTIC (UL 94V-0)  
 SHELL: COPPER ALLOY, NICKEL PLATING  
 TERMINAL: COPPER ALLOY, GOLD PLATED

**SPECIFICATION**

CURRENT RATING: 0.5 AMP MAX  
 DIELECTRIC WITHSTANDING: 500V AC FOR ONE MINUTE  
 CONTACT RESISTANCE: 100m OHMS MAX  
 INSULATION RESISTANCE: 1000M OHMS MIN AT DC 500V  
 OPERATION TEMPERATURE: -40°C~+85°C



A	RELEASE	2011.10.25
REV.	DESCRIPTION	DATE

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TOLERANCES	MEMORY CARD SERIES					
X.X ±0.3	TITLE SIM CARD, 6PIN, PCB MOUNT, SMT, METAL SHIELD					
X.XX ±0.2	DRAWN BY					
X.XXX ±0.1	CHECKED BY		APPROVED BY		UNIT	
Angle ±5°	<i>Janice</i>		<i>Lion</i>		<i>Benson</i>	
	SCALE	SIZE	DRAW NO.	REV.	Sheet	
10084	MM	NONE	A4	4MCGD-003	A	1/1